

RTL8363SC-VB-CG

#### LAYER 2 MANAGED 2+1-PORT 10/100/1000M SWITCH CONTROLLER

#### DRAFT DATASHEET

(CONFIDENTIAL: Development Partners Only)

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#### **USING THIS DOCUMENT**

This document is intended for the hardware and software engineer's general information on the Realtek RTL8363SC-VB IC.

Though every effort has been made to ensure that this document is current and accurate, more information may have become available subsequent to the production of this guide.

#### **REVISION HISTORY**

Revision	Release Date	Summary			
0.1	2016/07/15	First draft version.			
0.2	2016/08/16	Revise Table 21. DC Characteristics error.			
0.3	2016/08/22	Revise Table 21. DC Characteristics description and add note for power consumption.			



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#### 1. General Description

The RTL8363SC-VB-CG is a QFN-56, high-performance 2+1-port 10/100/1000M Ethernet switch featuring a low-power integrated 2-port Giga-PHY that supports 1000Base-T, 100Base-TX, and 10Base-T.

For specific applications, the RTL8363SC-VB supports one Ser-Des interface that could be configured as SGMII/HSGMII/1000Base-X/100FX interfaces. The RTL8363SC-VB integrates all the functions of a high-speed switch system; including SRAM for packet buffering, non-blocking switch fabric, and internal register management into a single CMOS device. Only a 25MHz crystal is required; an optional EEPROM is offered for internal register configuration.

The embedded packet storage SRAM in the RTL8363SC-VB features superior memory management technology to efficiently utilize memory space. The RTL8363SC-VB integrates a 2048-entry look-up table with a 4-way XOR Hashing algorithm for address searching and learning. The table provides read/write access from the Slave I<sup>2</sup>C-like serial Interface, or Slave Media Independent Interface Management (MIIM) Interface. Each of the entries can be configured as a static entry. Normal entry aging time is between 200 and 400 seconds. Eight Filtering Databases are used to provide Independent VLAN Learning and Shared VLAN Learning (IVL/SVL) functions.

The Extension GMAC1 of the RTL8363SC-VB implements a SGMII/HSGMII interfaces. This interface could be connected to an external PHY, MAC, CPU, or RISC for specific applications. In router applications, the RTL8363SC-VB supports Port VID (PVID) for each port to insert a PVID in the VLAN tag on egress. When using this function, VID information carried in the VLAN tag will be changed to PVID.

The RTL8363SC-VB supports standard 802.3x flow control frames for full duplex, and optional backpressure for half duplex. It determines when to invoke the flow control mechanism by checking the availability of system resources, including the packet buffers and transmitting queues. The RTL8363SC-VB supports broadcast/multicast output dropping, and will forward broadcast/multicast packets to non-blocked ports only. For IP multicast application, the RTL8363SC-VB supports trapping IPv4 IGMP v1/v2/v3 and IPv6 MLD v1/v2 to external CPU.

In order to support flexible traffic classification, the RTL8363SC-VB supports 48-entry ACL rule check and multiple actions options. Each port can optionally enable or disable the ACL rule check function. The ACL rule key can be based on packet physical port, Layer2, Layer3, and Layer4 information. When an ACL rule matches, the action taken is configurable to Drop/Permit/Redirect/Mirror, change priority value in 802.1q/Q tag, force output tag format and rate policing. The rate policing mechanism supports from 8Kbps to 1Gbps (in 8Kbps steps).

In Bridge operation the RTL8363SC-VB supports 16 sets of port configurations: disable, block, learning, and forwarding for Spanning Tree Protocol and Multiple Spanning Tree Protocol. To meet security and management application requirements, the RTL8363SC-VB supports IEEE 802.1x Port-based/MAC-based Access Control. A 1-set Port Mirroring function is configured to mirror traffic (RX, TX, or both) appearing on one of the switch's ports. Support is provided on each port for multiple RFC MIB Counters, for easy debug and diagnostics.

To improve real-time and multimedia networking applications, the RTL8363SC-VB supports eight priority assignments for each received packet. These are based on (1) Port-based priority; (2) 802.1p/Q VLAN tag priority; (3) DSCP field in IPv4/IPv6 header; and (4) ACL-assigned priority. Each output port



supports a weighted ratio of eight priority queues to fit bandwidth requirements in different applications. The input bandwidth control function helps limit per-port traffic utilization. There is one leaky bucket for average packet rate control for each queue of all ports. Queue scheduling algorithm can use Strict Priority (SP) or Weighted Fair Queue (WFQ) or Weighted Round Robin (WRR) or mixed.

The RTL8363SC-VB provides a 4K-entry VLAN table for 802.1Q port-based, tag-based, and protocol-based VLAN operation to separate logical connectivity from physical connectivity. The RTL8363SC-VB supports four Protocol-based VLAN configurations that can optionally select EtherType, LLC, and RFC1042 as the search key. Each port may be set to any topology via EEPROM upon reset, or Slave I<sup>2</sup>C-like serial Interface, or Slave Media Independent Interface Management (MIIM) Interface after reset.

In router applications, the router may want to know the input port of the incoming packet. The RTL8363SC-VB supports an option to insert a VLAN tag with VID=Port VID (PVID) on each egress port. The RTL8363SC-VB also provides an option to admit VLAN tagged packets with a specific PVID only. If this function is enabled, the RTL8363SC-VB will drop all non-tagged packets and packets with an incorrect PVID.

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#### 2. Features

- Single-chip 2+1-port 10/100/1000M non-blocking switch architecture
- Embedded 2-port 10/100/1000Base-T PHY
- Each port supports full duplex 10/100/1000M connectivity (half duplex only supported in 10/100M mode)
- Extra Interface (Extension GMAC1)
   Supports High Speed Serial Interface (Extension GMAC1)
  - ◆ SGMII (1.25Gbps) Interface
  - ♦ HSGMII (3.125Gbps) Interface
  - ♦ 1000Base-X Interface
  - ◆ 100FX Interface
- Full-duplex and half-duplex operation with IEEE 802.3x flow control and backpressure
- Supports 9216-byte jumbo packet length forwarding at wire speed
- Realtek Cable Test (RTCT) function
- Supports 48-entry ACL Rules
  - ◆ Search keys support physical port, Layer2, Layer3, and Layer4 information
  - ◆ Actions include mirror, redirect, dropping, priority adjustment, traffic policing, CVLAN decision, and SVLAN assignment GPIO control, force output tag format, interrupt and logging counter
  - ◆ Supports five types of user defined ACL rule format for 64 ACL rules
  - Optional per-port enable/disable of ACL function
  - ◆ Optional setting of per-port action to take when ACL mismatch
- Supports IEEE 802.1Q VLAN

- ◆ Supports 4096 VLANs and 32 Extra Enhanced VLANs
- ◆ Supports Un-tag definition in each VLAN
- Supports VLAN policing and VLAN forwarding decision
- Port-based, Tag-based, and Protocol-based VLAN
- ◆ Up to 4 Protocol-based VLAN entries
- Per-port and per-VLAN egress VLAN tagging and un-tagging
- Supports IVL, SVL, and IVL/SVL
  - ◆ 2048-entry MAC address table with 4-way hash algorithm
  - ◆ Up to 2048-entry L2/L3 Filtering Database
  - ◆ Per-port MAC learning limitation
  - ◆ System base MAC learning limitation
- Supports Spanning Tree Port Behavior configuration
  - ♦ IEEE 802.1w Rapid Spanning Tree
  - ◆ IEEE 802.1s Multiple Spanning Tree with up to 16 Spanning Tree instances
- Supports IEEE 802.1x Access Control Protocol
  - ◆ Port-Based Access Control
  - ◆ MAC-Based Access Control
- Supports Auto protection from Denial-of-Service attacks
- Support Trap IGMP/MLD packets to external CPU
- Supports Quality of Service (QoS)
  - ◆ Supports per port Input Bandwidth Control
  - ◆ Traffic classification based on IEEE 802.1p/Q priority definition, physical Port,



- IP DSCP field, ACL definition, VLAN based priority, MAC based priority and SVLAN based priority
- ◆ Eight Priority Queues per port
- ◆ Per queue flow control
- ◆ Min-Max Scheduling
- ◆ Strict Priority and Weighted Fair Queue (WFQ), Weighted Round Robin (WRR) packet scheduling
- ◆ One leaky bucket to constrain the average packet rate of each queue
- Supports rate limiting (12 shared meters, with 8kbps granulation or packets per second configuration)
- Supports RFC MIB Counter
  - ◆ MIB-II (RFC 1213)
  - ◆ Ethernet-Like MIB (RFC 3635)
  - ◆ Interface Group MIB (RFC 2863)
  - ◆ RMON (RFC 2819)
  - ◆ Bridge MIB (RFC 1493)
  - ◆ Bridge MIB Extension (RFC 2674)
- Supports Stacking VLAN and Port Isolation with eight Enhanced Filtering Databases
- Supports IEEE 802.1ad Stacking VLAN
  - ◆ Supports 64 SVLANs
  - ◆ Supports 32 L2/IPv4 Multicast mappings to SVLAN

- ◆ Supports MAC-based 1:N VLAN
- Supports Port Mirror function for one monitor port for multiple mirroring ports
- Security Filtering
  - ◆ Disable learning for each port
  - ◆ Disable learning-table aging for each port
  - ◆ Drop unknown DA for each port
- Broadcast/Multicast/Unknown DA storm control protects system from attack by hackers
- Supports IEEE 802.3az Energy Efficient Ethernet (EEE)
- Supports Realtek Green Ethernet features
  - ◆ Link-On Cable Length Power Saving
  - ◆ Link-Down Power Saving
- Each port supports 3 LED outputs
- Management Interface Supports
  - ◆ Slave I<sup>2</sup>C-like interface
  - ♦ Slave MII Management interface
- Supports 32K-byte EEPROM space for configuration
- Build in 3.3V to 1.1V switch regulator with power MOS
- 25MHz crystal or 3.3V OSC input
- QFN 56-pin package

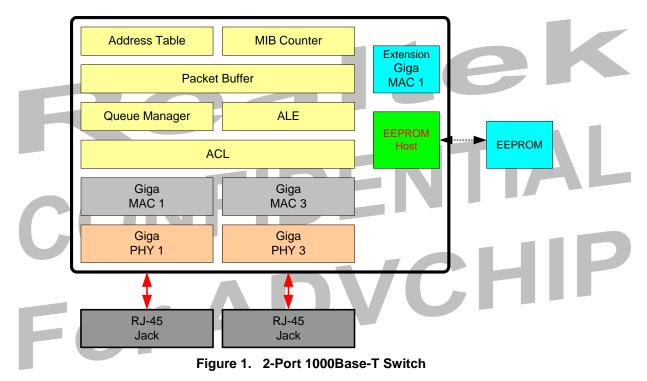


#### 3. System Applications

- 2-Port 1000Base-T Switch
- 2-Port 1000Base-T Router with SGMII/HSGMII

#### 4. Application Examples

#### 4.1. 2-Port 1000Base-T Switch





#### 4.2. 2-Port 1000Base-T Router with SGMII/HSGMII

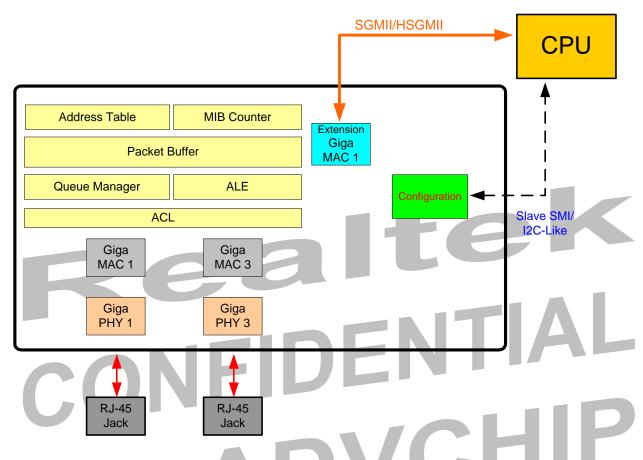


Figure 2. 2-Port 1000Base-T Router with SGMII/HSGMII

Note: Extra Interface (Extension GMAC1) in SGMII/HSGMII Mode.



#### 5. Block Diagram

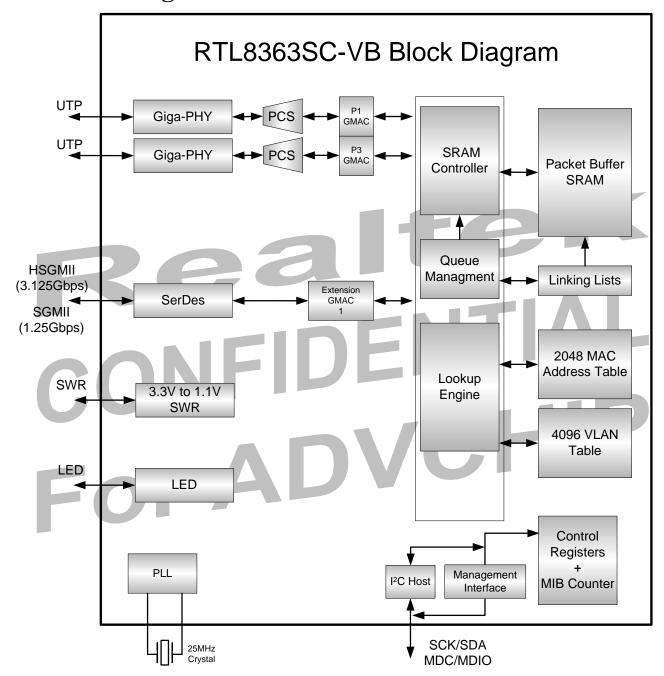


Figure 3. Block Diagram



#### 6. Pin Assignments

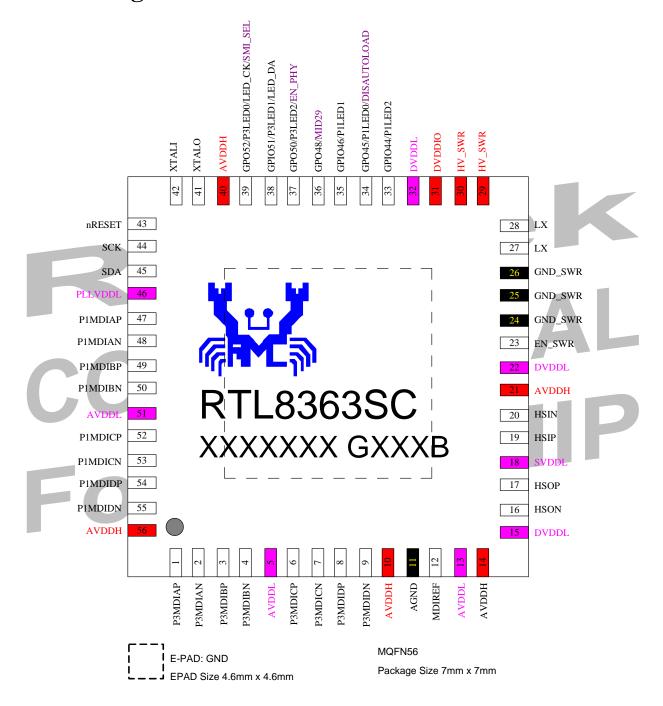


Figure 4. Pin Assignments (QFN-56)

#### 6.1. Package Identification

Green package is indicated by the 'G' in GXXX (Figure 4).



#### Pin Assignments Table

Upon Reset: Defined as a short time after the end of a hardware reset. After Reset: Defined as the time after the specified 'Upon Reset' time.

I: Input Pin AI: Analog Input Pin

O: Output Pin AO: Analog Output Pin

I/O: Bi-Directional Input/Output Pin AI/O: Analog Bi-Directional Input/Output Pin

P: Digital Power Pin AP: Analog Power Pin

G: Digital Ground Pin AG: Analog Ground Pin

I<sub>PU</sub>: Input Pin With Pull-Up Resistor; O<sub>PU</sub>: Output Pin With Pull-Up Resistor;

(Typical Value = 75K Ohm) (Typical Value = 75K Ohm)

I/O<sub>PU</sub>: Bi-Directional Input/Output Pin With Pull-Up Resistor;

(Typical Value = 75K Ohm)

Table 1. Pin Assignments Table

Name	Pin No.	Type
P3MDIAP	1	AI/O
P3MDIAN	2	AI/O
P3MDIBP	3	AI/O
P3MDIBN	4	AI/O
AVDDL	5	AP
P3MDICP	6	AI/O
P3MDICN	7	AI/O
P3MDIDP	8	AI/O
P3MDIDN	9	A/IO
AVDDH	10	AP
AGND	11	AG
MDIREF	12	AO
AVDDL	13	AP
AVDDH	14	AP
DVDDL	15	P
HSON	16	AO
HSOP	17	AO
SVDDL	18	AP
HSIP	19	AI
HSIN	20	AI
AVDDH	21	AP

Name	Pin No.	Type
DVDDL	22	P
EN_SWR	23	AI
GND_SWR	24	AG
GND_SWR	25	AG
GND_SWR	26	AG
LX	27	AO
LX	28	AO
HV_SWR	29	AP
HV_SWR	30	AP
DVDDIO	31	P
DVDDL	32	P
GPIO44/P1LED2	33	I/O <sub>PU</sub>
GPO45/P1LED0/	34	I/O <sub>PU</sub>
DISAUTOLOAD		
GPIO46/P1LED1	35	$I/O_{PU}$
GPO48/MID29	36	$I/O_{PU}$
GPO50/P3LED2/EN_PHY	37	I/O <sub>PU</sub>
GPIO51/P3LED1/LED_DA	38	I/O <sub>PU</sub>
GPO52/P3LED0/LED_CK/	39	I/O <sub>PU</sub>
SMI_SEL		
AVDDH	40	AP



Name	Pin No.	Type
XTALO	41	AO
XTALI	42	AI
nRESET	43	$I_{PU}$
SCK/MDC	44	I/O
SDA/MDIO	45	I/O
PLLVDDL	46	AP
P1MDIAP	47	AI/O
P1MDIAN	48	AI/O

Name	Pin No.	Type
P1MDIBP	49	AI/O
P1MDIBN	50	AI/O
AVDDL	51	AP
P1MDICP	52	AI/O
P1MDICN	53	AI/O
P1MDIDP	54	AI/O
P1MDIDN	55	AI/O
AVDDH	56	AP

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#### 7. Pin Descriptions

#### 7.1. Media Dependent Interface Pins

Table 2. Media Dependent Interface Pins

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Pin Name	Pin No.	Туре	Drive (mA)	Description
P1MDIAP/N	47	AI/O	10	Port 1 Media Dependent Interface A~D.
	48			For 1000Base-T operation, differential data from the media is transmitted
P1MDIBP/N	49			and received on all four pairs. For 100Base-TX and 10Base-T operation,
	50			only MDIAP/N and MDIBP/N are used. Auto MDIX can reverse the pairs
P1MDICP/N	52			MDIAP/N and MDIBP/N.
	53			
P1MDIDP/N	54			Each of the differential pairs has an internal 100-ohm termination resistor.
	55			
P3MDIAP/N	1	AI/O	10	Port 3 Media Dependent Interface A~D.
	2			For 1000Base-T operation, differential data from the media is transmitted
P3MDIBP/N	3			and received on all four pairs. For 100Base-TX and 10Base-T operation,
	4			only MDIAP/N and MDIBP/N are used. Auto MDIX can reverse the pairs
P3MDICP/N	6			MDIAP/N and MDIBP/N.
	7			
P3MDIDP/N	8			Each of the differential pairs has an internal 100-ohm termination resistor.
	9			

#### 7.2. High Speed Serial Interface Pins

#### Table 3. High Speed Serial Interface Pins

Pin Name Pin No. Type		Drive (mA)	Description	
HSOP/N	17 16	AO	10	High Speed Serial Output Pins: 1.25GHz/3.125GHz Differential serial interface to transmit data. Keep floating when unused.
HSIP/N	19 20	AI	10	High Speed Serial Input Pins: 1.25GHz/3.125GHz Differential serial interface to receive data. Keep floating when unused.

#### 7.3. General Purpose Interface Pins

Table 4. General Purpose Interfaces Pins

Pin No.	GPIO	Other function	Configuration Strapping
33	GPIO44	P1LED2	ı
34	GPO45	P1LED0	DISAUTOLOAD
35	GPIO46	P1LED1	-
36	GPO48	-	MID29
37	GPO50	P3LED2	EN_PHY
38	GPIO51	P3LED1/ LED_DA	-



Pin No.	GPIO	Other function	Configuration Strapping	
39	GPO52	P3LED0/ LED_CK	SMI_SEL	

#### 7.4. LED Pins

The RTL8363SC-VB LED Pins can be configured to parallel mode LED interface via Register configuration. LED of Port n indicates information that can be defined via register or EEPROM.

In parallel mode LED interface, when the LED pin is pulled low, the LED output polarity will be high active. When the LED pin is pulled high, the LED output polarity will change from high active to low active. See section 9.17 LED Indicators, page 29 for more details.

Table 5. LED Pins

				Table J. LED I III3		
Pin Name	Pin No.	Туре	Drive (mA)	Description		
P3LED2/	37	I/O <sub>PU</sub>	-	P3LED2 Output Signal.		
GPO50/				P3LED2 indicates information is defined by register or EEPROM.		
EN_PHY				See section 9.17 LED Indicators, page 29 for more details.		
P3LED1/	38	I/O <sub>PU</sub>		P3LED1 Output Signal.		
GPIO51/				P3LED1 indicates information is defined by register or EEPROM.		
LED_DA				See section 9.17 LED Indicators, page 29 for more details.		
P3LED0/	39	I/O <sub>PU</sub>		P3LED0 Output Signal.		
GPO52/				A 9		
LED_CK/			-	- P3LED0 indicates information is defined by register or EEPROM. See section 9.17 LED Indicators, page 29 for more details.		
SMI_SEL				See section 7.17 EED midicators, page 25 for more details.		
P1LED2/	33	$I/O_{PU}$	-/ \	P1LED2 Output Signal.		
GPIO44				P1LED2 indicates information is defined by register or EEPROM.		
				See section 9.17 LED Indicators, page 29 for more details.		
P1LED1/	35	I/O <sub>PU</sub>		P1LED1 Output Signal.		
GPIO46				P1LED1 indicates information is defined by register or EEPROM.		
				See section 9.17 LED Indicators, page 29 for more details.		
P1LED0/	34	$I/O_{PU}$	-	P1LED0 Output Signal.		
GPO45/				P1LED0 indicates information is defined by register or EEPROM.		
DISAUTOLOAD				See section 9.17 LED Indicators, page 29 for more details.		



#### 7.5. Configuration Strapping Pins

Table 6. Configuration Strapping Pins

Pin Name	Pin No.	Type	Description	
DISAUTOLOAD/	34	I/O <sub>PU</sub>	Disable EEPROM Autoload.	
GPO45/			Pull Up: Disable EEPROM autoload	
P1LED0			Pull Down: Enable EEPROM autoload	
			Note 1: This pin must be kept floating, or pulled high or low via an external 4.7k	
			ohm resistor upon power on or reset.	
			When this pin is pulled low, the LED output polarity will be high active. When this	
			pin is pulled high, the LED output polarity will change from high active to low	
			active. See section 9.19 LED Indicators, page 44 for more details.	
MID29/	36	I/O <sub>PU</sub>	Slave SMI (MDC/MDIO) Device Address.	
GPO48			Pull Up: Slave SMI (MDC/MDIO) Device Address is d'29	
			Pull Down: Slave SMI (MDC/MDIO) Device Address is 0	
			Note: This pin must be kept floating, or pulled high or low via an external 4.7k	
			ohm resistor upon power on or reset.	
EN_PHY/	37	I/O <sub>PU</sub>	Enable Embedded PHY.	
GPO50/			Pull Up: Enable embedded PHY	
P3LED2			Pull Down: Disable embedded PHY	
			Note: This pin must be kept floating, or pulled high or low via an external	
			4.7k ohm resistor upon power on or reset.	
			When this pin is pulled low, the LED output polarity will be high active. When this	
			pin is pulled high, the LED output polarity will change from high active to low	
			active. See section 9.17 LED Indicators, page 29 for more details.	
SMI_SEL/	39	I/O <sub>PU</sub>	Slave I2C-like/Slave MII Management Interface Selection.	
GPO52/			Pull Up: Slave I <sup>2</sup> C-like interface	
P3LED0/			Pull Down: Slave MII Management interface	
LED_CK			Note: This pin must be kept floating, or pulled high or low via an external	
			4.7k ohm resistor upon power on or reset.	
			When this pin is pulled low, the LED output polarity will be high active. When this	
			pin is pulled high, the LED output polarity will change from high active to low	
			active. See section 9.17 LED Indicators, page 29 for more details.	

#### 7.6. Management Interface Pins

**Table 7. Management Interface Pins** 

Pin Name	Pin No.	Type	Description	
SCK/ MDC	44	I/O	Master I2C Interface Clock for EEPROM auto-download. Slave I2C Interface Clock for external CPU to access DUT.	
			Slave MII Management Interface Clock (selected via the hardware strapping SMI_SEL).	
SDA/	45	I/O	Master I2C Interface Data for EEPROM auto-download.	
MDIO			Slave I2C Interface Data for external CPU to access DUT.	
			Slave MII Management Interface Data (selected via the hardware strapping	
			SMI_SEL).	



#### 7.7. Miscellaneous Pins

**Table 8. Miscellaneous Pins** 

Pin Name	Pin No.	Type	Description
MDIREF	12	AO	Reference Resistor.
			A 2.49K ohm (1%) resistor must be connected between MDIREF and GND.
GPIO44	33	I/O <sub>PU</sub>	General Purpose Input/Output Interface IO44.
P1LED2			
GPO45/	34	I/O <sub>PU</sub>	General Purpose Output Interface IO45.
P1LED0/			
DISAUTOLOAD			
GPIO46/	35	I/O <sub>PU</sub>	General Purpose Input/Output Interface IO46.
P1LED1			
GPO48/	36	I/O <sub>PU</sub>	General Purpose Output Interface IO48.
MID29			
GPO50/	37	I/O <sub>PU</sub>	General Purpose Output Interface IO50.
P3LED2/			
EN_PHY			
GPIO51/	38	I/O <sub>PU</sub>	General Purpose Input/Output Interface IO51.
P3LED1/			
LED_DA			- IBERLIAL
GPO52/	39	I/O <sub>PU</sub>	General Purpose Output Interface IO52.
P3LED0/			
LED_CK/			
SMI_SEL			
XTALO	41	AO	25MHz Crystal Clock Output Pin.
XTALI	42	AI	25MHz Crystal Clock Input Pin.
			25MHz +/-50ppm tolerance crystal reference.
			When using a crystal, connect a loading capacitor between crystal pin and
			ground. When either using an oscillator or driving an external 25MHz clock
			from another device, XTALO should kept floating.
nRESET	43	$I_{PU}$	System Reset Input Pin.
			When low active will reset the RTL8363SC-VB-CG.

#### 7.8. Embedded Switch Regulator Pins

Table 9. Embedded Switch Regulator Pins

Table 5. Ellibedded Switch Negdiator Filis					
Pin Name	Pin No.	Type	Description		
EN_SWR	23	AI	Enable embedded switch regulator.		
			Pull Up: Enable embedded switch regulator.		
			Pull Down: Disable embedded switch regulator.		
			Note: pulled high or low via an external 4.7k ohm resistor to enable or		
			disable embedded switch regulator.		
GND_SWR	24, 25, 26	AG	Regulator Ground.		
LX	27, 28	AO	Regulator output. It should connect to the external inductor.		
HV_SWR	29, 30	AP	Regulator Power Supply Input.		



#### 7.9. Power and GND Pins

#### Table 10. Power and GND Pins

Pin Name	Pin No.	Type	Description		
DVDDIO	31	P	Digital I/O High Voltage Power for LED, Management Interface, and nRESET.		
DVDDL	15, 22, 32	P	Digital Low Voltage Power.		
AVDDH	10, 14, 21, 40, 56,	AP	Analog High Voltage Power.		
AVDDL	5, 13, 51	AP	Analog Low Voltage Power.		
SVDDL	18	AP	SerDes Low Voltage Power.		
PLLVDDL	46	AP	PLL Low Voltage Power.		
GND	E-PAD	G	GND.		
AGND	11	AG	Analog GND.		





#### 8. Physical Layer Functional Overview

#### 8.1. MDI Interface

The RTL8363SC-VB embeds two 10/100/1000M Ethernet PHYs in one chip. Each port uses a single common MDI interface to support 1000Base-T, 100Base-TX, and 10Base-T. This interface consists of four signal pairs-A, B, C, and D. Each signal pair consists of two bi-directional pins that can transmit and receive at the same time. The MDI interface has internal termination resistors, and therefore reduces BOM cost and PCB complexity. For 1000Base-T, all four pairs are used in both directions at the same time. For 10/100 links and during auto-negotiation, only pairs A and B are used.

#### 8.2. 1000Base-T Transmit Function

The 1000Base-TX transmit function performs 8B/10B coding, scrambling, and 4D-PAM5 encoding. These code groups are passed through a waveform-shaping filter to minimize EMI effects, and are transmitted onto 4-pair CAT5 cable at 125MBaud/s through a D/A converter.

#### 8.3. 1000Base-T Receive Function

Input signals from the media pass through the sophisticated on-chip hybrid circuit to subtract the transmitted signal from the input signal for effective reduction of near-end echo. The received signal is then processed with state-of-the-art technology, e.g., adaptive equalization, BLW (Baseline Wander) correction, cross-talk cancellation, echo cancellation, timing recovery, error correction, and 4D-PAM5 decoding. The 8-bit-wide data is recovered and is sent to the GMII interface at a clock speed of 125MHz. The RX MAC retrieves the packet data from the internal receive MII/GMII interface and sends it to the packet buffer manager.

#### 8.4. 100Base-TX Transmit Function

The 100Base-TX transmit function performs parallel to serial conversion, 4B/5B coding, scrambling, NRZ/NRZI conversion, and MLT-3 encoding. The 5-bit serial data stream after 4B/5B coding is then scrambled as defined by the TP-PMD Stream Cipher function to flatten the power spectrum energy such that EMI effects can be reduced significantly.

The scrambled seed is based on PHY addresses and is unique for each port. After scrambling, the bit stream is driven onto the network media in the form of MLT-3 signaling. The MLT-3 multi-level signaling technology moves the power spectrum energy from high frequency to low frequency, which also reduces EMI emissions.



#### 8.5. 100Base-TX Receive Function

The receive path includes a receiver composed of an adaptive equalizer and DC restoration circuits (to compensate for an incoming distorted MLT-3 signal), an MLT-3 to NRZI and NRZI to NRZ converter to convert analog signals to digital bit-stream, and a PLL circuit to clock data bits with minimum bit error rate. A de-scrambler, 5B/4B decoder, and serial-to-parallel conversion circuits are followed by the PLL circuit. Finally, the converted parallel data is fed into the MAC.

#### 8.6. 10Base-T Transmit Function

The output 10Base-T waveform is Manchester-encoded before it is driven onto the network media. The internal filter shapes the driven signals to reduce EMI emissions, eliminating the need for an external filter.

#### 8.7. 10Base-T Receive Function

The Manchester decoder converts the incoming serial stream to NRZ data when the squelch circuit detects the signal level is above squelch level.

#### 8.8. Auto-Negotiation for UTP

The RTL8363SC-VB obtains the states of duplex, speed, and flow control ability for each port in UTP mode through the auto-negotiation mechanism defined in the IEEE 802.3 specifications. During auto-negotiation, each port advertises its ability to its link partner and compares its ability with advertisements received from its link partner. By default, the RTL8363SC-VB advertises full capabilities (1000Full, 100Full, 10Full, 10Full, 10Half) together with flow control ability.



#### 8.9. Crossover Detection and Auto Correction

The RTL8363SC-VB automatically determines whether or not it needs to crossover between pairs (see Table 11) so that an external crossover cable is not required. When connecting to another device that does not perform MDI crossover, when necessary, the RTL8363SC-VB automatically switches its pin pairs to communicate with the remote device. When connecting to another device that does have MDI crossover capability, an algorithm determines which end performs the crossover function.

The crossover detection and auto correction function can be disabled via register configuration. The pin mapping in MDI and MDI Crossover mode is given below.

rabio : :: moana = oponaciii : mapping								
Pairs		MDI		MDI Crossover				
	1000Base-T	100Base-TX	10Base-T	1000Base-T	100Base-TX	10Base-T		
A	A	TX	TX	В	RX	RX		
В	В	RX	RX	A	TX	TX		
C	C	Unused	Unused	D	Unused	Unused		
D	D	Unused	Unused	С	Unused	Unused		

Table 11. Media Dependent Interface Pin Mapping

#### 8.10. Polarity Correction

The RTL8363SC-VB automatically corrects polarity errors on the receiver pairs in 1000Base-T and 10Base-T modes. In 100Base-TX mode, the polarity is irrelevant.

In 1000Base-T mode, receive polarity errors are automatically corrected based on the sequence of idle symbols. Once the de-scrambler is locked, the polarity is also locked on all pairs. The polarity becomes unlocked only when the receiver loses lock.

In 10Base-T mode, polarity errors are corrected based on the detection of valid spaced link pulses. The detection begins during the MDI crossover detection phase and locks when the 10Base-T link is up. The polarity becomes unlocked when the link is down.

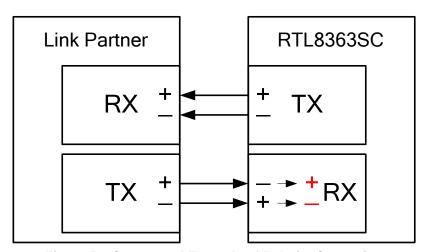


Figure 5. Conceptual Example of Polarity Correction



#### 9. General Function Description

#### 9.1. Reset

#### 9.1.1. Hardware Reset

In a power-on reset, an internal power-on reset pulse is generated and the RTL8363SC-VB will start the reset initialization procedures. These are:

- Determine various default settings via the hardware strap pins at the end of the nRESET signal
- Autoload the configuration from EEPROM if EEPROM is detected
- Complete the embedded SRAM BIST process
- Initialize the packet buffer descriptor allocation
- Initialize the internal registers and prepare them to be accessed by the external CPU

#### 9.1.2. Software Reset

The RTL8363SC-VB supports two software resets; a chip reset and a soft reset.

#### 9.1.2.1 CHIP\_RESET

When CHIP\_RESET is set to 0b1 (write and self-clear), the chip will take the following steps:

- 1. Download configuration from strap pin and EEPROM
- 2. Start embedded SRAM BIST (Built-In Self Test)
- 3. Clear all the Lookup and VLAN tables
- 4. Reset all registers to default values
- 5. Restart the auto-negotiation process

#### 9.1.2.2 SOFT RESET

When SOFT\_RESET is set to 0b1 (write and self-clear), the chip will take the following steps:

- 1. Clear the FIFO and re-start the packet buffer link list
- 2. Restart the auto-negotiation process

#### 9.2. IEEE 802.3x Full Duplex Flow Control

The RTL8363SC-VB supports IEEE 802.3x flow control in 10/100/1000M modes. Flow control can be decided in two ways:

- When Auto-Negotiation is enabled, flow control depends on the result of NWay
- When Auto-Negotiation is disabled, flow control depends on register definition



#### 9.3. Half Duplex Flow Control

In half duplex mode, the CSMA/CD media access method is the means by which two or more stations share a common transmission medium. To transmit, a station waits (defers) for a quiet period on the medium (that is, no other station is transmitting) and then sends the intended message in bit-serial form. If the message collides with that of another station, then each transmitting station intentionally transmits for an additional predefined period to ensure propagation of the collision throughout the system. The station remains silent for a random amount of time (backoff) before attempting to transmit again.

When a transmission attempt has terminated due to a collision, it is retried until it is successful. The scheduling of the retransmissions is determined by a controlled randomization process called "Truncated Binary Exponential Backoff". At the end of enforcing a collision (jamming), the switch delays before attempting to retransmit the frame. The delay is an integer multiple of slot time (512 bit times). The number of slot times to delay before the nth retransmission attempt is chosen as a uniformly distributed random integer 'r' in the range:

 $0 \le r \le 2k$ 

where:

k = min (n, backoffLimit). The backoffLimit for the RTL8363SC-VB is 9.

The half duplex back-off algorithm in the RTL8363SC-VB does not have the maximum retry count limitation of 16 (as defined in IEEE 802.3). This means packets in the switch will not be dropped if the back-off retry count is over 16.

#### 9.3.1. Back-Pressure Mode

In Back-Pressure mode, the RTL8363SC-VB sends a 4-byte jam pattern (data=0xAA) to collide with incoming packets when congestion control is activated. The Jam pattern collides at the fourth byte counted from the preamble. The RTL8363SC-VB supports 48PASS1, which receives one packet after 48 consecutive jam collisions (data collisions are not included in the 48). Enable this function to prevent port partition after 63 consecutive collisions (data collisions + consecutive jam collisions).



#### 9.4. Search and Learning

#### Search

When a packet is received, the RTL8363SC-VB uses the destination MAC address, Filtering Identifier (FID) and Enhanced Filtering Identifier (EFID) to search the 2K-entry look-up table. The 48-bit MAC address, 4-bit FID and 3-bit EFID use a hash algorithm, to calculate an 11-bit index value. The RTL8363SC-VB uses the index to compare the packet MAC address with the entries (MAC addresses) in the look-up table. This is the 'Address Search'. If the destination MAC address is not found, the switch will broadcast the packet according to VLAN configuration.

#### Learning

The RTL8363SC-VB uses the source MAC address, FID, and EFID of the incoming packet to hash into a 9-bit index. It then compares the source MAC address with the data (MAC addresses) in this index. If there is a match with one of the entries, the RTL8363SC-VB will update the entry with new information. If there is no match and the 2K entries are not all occupied by other MAC addresses, the RTL8363SC-VB will record the source MAC address and ingress port number into an empty entry. This process is called 'Learning'.

Address aging is used to keep the contents of the address table correct in a dynamic network topology. The look-up engine will update the time stamp information of an entry whenever the corresponding source MAC address appears. An entry will be invalid (aged out) if its time stamp information is not refreshed by the address learning process during the aging time period. The aging time of the RTL8363SC-VB is between 200 and 400 seconds (typical is 300 seconds).

#### 9.5. SVL and IVL/SVL

The RTL8363SC-VB supports a 16-group Filtering Identifier (FID) for L2 search and learning. In default operation, all VLAN entries belong to the same FID. This is called Shared VLAN Learning (SVL). If VLAN entries are configured to different FIDs, then the same source MAC address with multiple FIDs can be learned into different look-up table entries. This is called Independent VLAN Learning and Shared VLAN Learning (IVL/SVL).

#### 9.6. Illegal Frame Filtering

Illegal frames such as CRC error packets, runt packets (length <64 bytes), and oversize packets (length >maximum length) will be discarded by the RTL8363SC-VB. The maximum packet length may be set from 1518 bytes to 16K bytes.



#### 9.7. IEEE 802.3 Reserved Group Addresses Filtering Control

The RTL8363SC-VB supports the ability to drop/forward IEEE 802.3 specified reserved group MAC addresses: 01-80-C2-00-00-00 to 01-80-C2-00-00-2F. The default setting enables forwarding of these reserved group MAC address control frames. Frames with group MAC address 01-80-C2-00-00-01 (802.3x Pause) and 01-80-C2-00-00-02 (802.3ad LACP) will always be filtered. Table 12 shows the Reserved Multicast Address (RMA) configuration mode from 01-80-C2-00-00-00 to 01-80-C2-00-00-2F.

**Table 12. Reserved Multicast Address Configuration Table** 

Assignment Assignment	Value
Bridge Group Address	01-80-C2-00-00-00
IEEE Std 802.3, 1988 Edition, Full Duplex PAUSE Operation	01-80-C2-00-00-01
IEEE Std 802.3ad Slow Protocols-Multicast Address	01-80-C2-00-00-02
IEEE Std 802.1X PAE Address	01-80-C2-00-00-03
Provider Bridge Group Address	01-80-C2-00-00-08
Undefined 802.1 Address	01-80-C2-00-00-04 ~
	01-80-C2-00-00-07
	&
	01-80-C2-00-00-09 ~
	01-80-C2-00-00-0C
	&
	01-80-C2-00-00-0F
Provider Bridge MVRP Address	01-80-C2-00-00-0D
IEEE Std 802.1AB Link Layer Discovery Protocol Address	01-80-C2-00-00-0E
All LANs Bridge Management Group Address	01-80-C2-00-00-10
Load Server Generic Address	01-80-C2-00-00-11
Loadable Device Generic Address	01-80-C2-00-00-12
Undefined 802.1 Address	01-80-C2-00-00-13 ~
FOR AIJV	01-80-C2-00-00-17
	&
	01-80-C2-00-00-19
	&
	01-80-C2-00-00-1B ~
C All C All M C C	01-80-C2-00-00-1F
Generic Address for All Manager Stations	01-80-C2-00-00-18
Generic Address for All Agent Stations	01-80-C2-00-00-1a
GMRP Address	01-80-C2-00-00-20
GVRP Address	01-80-C2-00-00-21
Undefined GARP Address	01-80-C2-00-00-22
	01-80-C2-00-00-2F
CDP(Cisco Discovery Protocol)	01-00-0C-CC-CC
CSSTP(Cisco Shared Spanning Tree Protocol)	01-00-0C-CC-CC
LLDP	(01:80:c2:00:00:0e or
	01:80:c2:00:00:03 or
	01:80:c2:00:00:00) && ethertype = 0x88CC
	&& emertype = 0x88CC



#### 9.8. Broadcast/Multicast/Unknown DA Storm Control

The RTL8363SC-VB enables or disables per-port broadcast/multicast/unknown DA storm control by setting registers (default is disabled). After the receiving rate of broadcast/multicast/unknown DA packets exceeds a reference rate (number of Kbps per second or number of packets per second), all other broadcast/multicast/unknown DA packets will be dropped. The reference rate is set via register configuration.

#### 9.9. Port Security Function

The RTL8363SC-VB supports three types of security function to prevent malicious attacks:

- Per-port enable/disable SA auto-learning for an ingress packet
- Per-port enable/disable look-up table aging update function for an ingress packet
- Per-port enable/disable drop all unknown DA packets

#### 9.10. MIB Counters

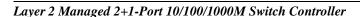
The RTL8363SC-VB supports a set of counters to support management functions.

- MIB-II (RFC 1213)
- Ethernet-Like MIB (RFC 3635)
- Interface Group MIB (RFC 2863)
- RMON (RFC 2819)
- Bridge MIB (RFC 1493)
- Bridge MIB Extension (RFC 2674)

#### 9.11. Port Mirroring

The RTL8363SC-VB supports one set of port mirroring functions for all ports. The TX, or RX, or both TX/RX packets from multiple mirrored port can be mirrored to one monitor port.

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#### 9.12. VLAN Function

The RTL8363SC-VB supports 4096 VLAN groups. These can be configured as port-based VLANs, IEEE 802.1Q tag-based VLANs, and Protocol-based VLANs. Two ingress-filtering and egress-filtering options provide flexible VLAN configuration:

#### **Ingress Filtering**

- The acceptable frame type of the ingress process can be set to 'Admit All', 'Admit only Untagged' or 'Admit only Tagged'
- 'Admit' or 'Discard' frames associated with a VLAN for which that port is not in the member set

#### **Egress Filtering**

- 'Forward' or 'Discard' Leaky VLAN frames between different VLAN domains
- 'Forward' or 'Discard' Multicast VLAN frames between different VLAN domains

The VLAN tag can be inserted or removed at the output port. The RTL8363SC-VB will insert a Port VID (PVID) for untagged frames, or remove the tag from tagged frames. The RTL8363SC-VB also supports a special insert VLAN tag function to separate traffic from the WAN and LAN sides in Router and Gateway applications.

In router applications, the router may want to know which input port this packet came from. The RTL8363SC-VB supports Port VID (PVID) for each port and can insert a PVID in the VLAN tag on egress. Using this function, VID information carried in the VLAN tag will be changed to PVID. The RTL8363SC-VB also provides an option to admit VLAN tagged packets with a specific PVID only. If this function is enabled, it will drop non-tagged packets and packets with an incorrect PVID.

#### 9.12.1. Port-Based VLAN

This default configuration of the VLAN function can be modified via an attached serial EEPROM or EEPROM SMI Slave interface. The 4K-entry VLAN Table designed into the RTL8363SC-VB provides full flexibility for users to configure the input ports to associate with different VLAN groups. Each input port can join with more than one VLAN group.

Port-based VLAN mapping is the simplest implicit mapping rule. Each ingress packet is assigned to a VLAN group based on the input port. It is not necessary to parse and inspect frames in real-time to determine their VLAN association. All the packets received on a given input port will be forwarded to this port's VLAN members.

#### 9.12.2. IEEE 802.1Q Tag-Based VLAN

The RTL8363SC-VB supports 4096 VLAN entries to perform 802.1Q tag-based VLAN mapping. In 802.1Q VLAN mapping, the RTL8363SC-VB uses a 12-bit explicit identifier in the VLAN tag to associate received packets with a VLAN. The RTL8363SC-VB compares the explicit identifier in the VLAN tag with the 4K VLAN Table to determine the VLAN association of this packet, and then forwards this packet to the member set of that VLAN. Two VIDs are reserved for special purposes. One of them is all 1's, which is reserved and currently unused. The other is all 0's, which indicates a priority tag. A priority-tagged frame should be treated as an untagged frame.



When '802.1Q tag aware VLAN' is enabled, the RTL8363SC-VB performs 802.1Q tag-based VLAN mapping for tagged frames, but still performs port-based VLAN mapping for untagged frames. If '802.1Q tag aware VLAN' is disabled, the RTL8363SC-VB performs only port-based VLAN mapping both on non-tagged and tagged frames. The processing flow when '802.1Q tag aware VLAN' is enabled is illustrated below.

Two VLAN ingress filtering functions are supported in registers by the RTL8363SC-VB. One is the 'VLAN tag admit control, which provides the ability to receive VLAN-tagged frames only. Untagged or priority tagged (VID=0) frames will be dropped. The other is 'VLAN member set ingress filtering', which will drop frames if the ingress port is not in the member set.

#### 9.12.3. Protocol-Based VLAN

The RTL8363SC-VB supports a 4-group Protocol-based VLAN configuration. The packet format can be RFC 1042, LLC, or Ethernet, as shown in Figure 6. There are 4 configuration tables to assign the frame type and corresponding field value. Taking IP packet configuration as an example, the user can configure the frame type to be 'Ethernet', and value to be '0x0800'. Each table will index to one of the entries in the 4K-entry VLAN table. The packet stream will match the protocol type and the value will follow the VLAN member configuration of the indexed entry to forward the packets.

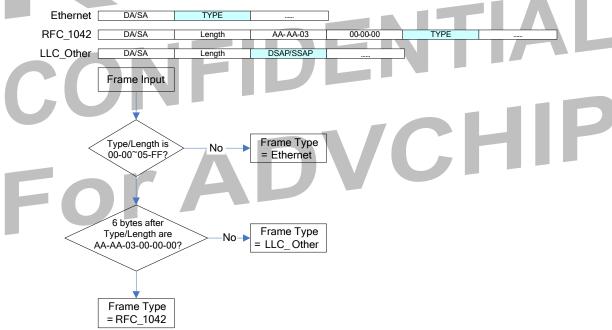


Figure 6. Protocol-Based VLAN Frame Format and Flow Chart

#### **9.12.4.** Port VID

In a router application, the router may want to know which input port this packet came from. The RTL8363SC-VB supports Port VID (PVID) for each port to insert a PVID in the VLAN tag for untagged or priority tagged packets on egress. When 802.1Q tag-aware VLAN is enabled, VLAN tag admit control is enabled, and non-PVID Discard is enabled at the same time. When these functions are enabled, the RTL8363SC-VB will drop non-tagged packets and packets with an incorrect PVID.



#### 9.13. QoS Function

The RTL8363SC-VB supports 8 priority queues and input bandwidth control. Packet priority selection can depend on Port-based priority, 802.1p/Q Tag-based priority, IPv4/IPv6 DSCP-based priority, and ACL-based priority. When multiple priorities are enabled in the RTL8363SC-VB, the packet's priority will be assigned based on the priority selection table.

Each queue has one leaky bucket for Average Packet Rate. Per-queue in each output port can be set as Strict Priority (SP) or Weighted Fair Queue (WFQ) or Weighted Round Robin (WRR) for packet scheduling algorithm.

#### 9.13.1. Input Bandwidth Control

Input bandwidth control limits the input bandwidth. When input traffic is more than the RX Bandwidth parameter, this port will either send out a 'pause ON' frame, or drop the input packet depending on register setup. Per-port input bandwidth control rates can be set from 8Kbps to 1Gbps (in 8Kbps steps).

#### 9.13.2. Priority Assignment

Priority assignment specifies the priority of a received packet according to various rules. The RTL8363SC-VB can recognize the QoS priority information of incoming packets to give a different egress service priority.

The RTL8363SC-VB identifies the priority of packets based on several types of QoS priority information:

- Port-based priority
- 802.1p/Q-based priority
- IPv4/IPv6 DSCP-based priority
- ACL-based priority
- VLAN-based priority
- MAC-based priority
- SVLAN-based priority

#### 9.13.3. Priority Queue Scheduling

The RTL8363SC-VB supports 8 priority queues and input bandwidth control. Packet priority selection can depend on Port-based priority, 802.1p/Q Tag-based priority, IPv4/IPv6 DSCP-based priority, and ACL-based priority. When multiple priority be enabled in the RTL8363SC-VB, the packet's priority will be assigned based on the priority selection table.

The RTL8363SC-VB scheduler operates as follows:

- Strict Priority (SP)
- Weighted Fair-Queuing (WFQ): Byte-count
- Weighted Round-Robin (WRR): Packet-count

WFQ and WRR cannot exist at the same time. WFQ or WRR can co-exist with Strict Priority Schedule.



#### 9.13.4. IEEE 802.1p/Q and DSCP Remarking

The RTL8363SC-VB supports the IEEE 802.1p/Q and IP DSCP (Differentiated Services Code Point) remarking function. When packets egress from one of the 8 queues, the packet's 802.1p/Q priority and IP DSCP can optionally be remarked to a configured value. 802.1p/Q priority & IP DSCP value can be remarked based on internal priority or original 802.1p/Q priority & IP DSCP value in packets.

#### 9.13.5. ACL-Based Priority

The RTL8363SC-VB supports 48-entry ACL (Access Control List) rules. When a packet is received, its physical port, Layer2, Layer3, and Layer4 information are recorded and compared to ACL entries.

If a received packet matches multiple entries, the entry with the lowest address is valid. If the entry is valid, the action bit and priority bit will be applied.

- If the action bit is 'Drop', the packet will be dropped. If the action bit is 'CPU', the packet will be trapped to the CPU instead of forwarded to non-CPU ports (except where it will be dropped by rules other than the ACL rule)
- If the action bit is 'Permit', ACL rules will override other rules
- If the action bit is 'Mirror', the packet will be forwarded to the mirror port and the L2 lookup result destination port. The mirror port indicates the port configured in the port mirror mechanism
- The priority bit will take effect only if the action bit is 'CPU', 'Permit', and 'Mirror'. The Priority bit is used to determine the packet queue ID according to the priority assignment mechanism

#### 9.14. IEEE 802.1x Function

The RTL8363SC-VB supports IEEE 802.1x Port-based/MAC-based Access Control.

- Port-Based Access Control for each port
- Authorized Port-Based Access Control for each port
- Port-Based Access Control Direction for each port
- MAC-Based Access Control for each port
- MAC-Based Access Control Direction
- Optional Unauthorized Behavior

#### 9.14.1. Port-Based Access Control

Each port of the RTL8363SC-VB can be set to 802.1x port-based authenticated checking function usage and authorized status. Ports with 802.1X unauthorized status will drop received/transmitted frames.

#### 9.14.2. Authorized Port-Based Access Control

If a dedicated port is set to 802.1x port-based access control, and passes the 802.1x authorization, then its port authorization status can be set to authorized.



#### 9.14.3. Port-Based Access Control Direction

Ports with 802.1X unauthorized status will drop received/transmitted frames only when port authorization direction is 'BOTH'. If the authorization direction of an 802.1X unauthorized port is IN, incoming frames to that port will be dropped, but outgoing frames will be transmitted.

#### 9.14.4. MAC-Based Access Control

MAC-Based Access Control provides authentication for multiple logical ports. Each logical port represents a source MAC address. There are multiple logical ports for a physical port. When a logical port or a MAC address is authenticated, the relevant source MAC address has the authorization to access the network. A frame with a source MAC address that is not authenticated by the 802.1x function will be dropped or trapped to the CPU.

#### 9.14.5. MAC-Based Access Control Direction

Unidirectional and Bi-directional control are two methods used to process frames in 802.1x. As the system cannot predict which port the DA is on, a system-wide MAC-based access control direction setup is provided for determining whether receiving or bi-direction should be authorized.

If MAC-based access control direction is BOTH, then received frames with unauthenticated SA or unauthenticated DA will be dropped. When MAC-based access control direction is IN, only received frames with unauthenticated SA will be dropped.

#### 9.14.6. Optional Unauthorized Behavior

Both in Port-Based Network Access Control and MAC-Based Access Control, a whole system control setup is provided to determine unauthorized frame dropping, trapping to CPU, or tagging as belonging to a Guest VLAN (see the following 'Guest VLAN' section).

#### 9.15. IEEE 802.1D Function

When using IEEE 802.1D, the RTL8363SC-VB supports 16 sets and four status' for each port for CPU implementation 802.1D (STP) and 802.1s (MSTP) function:

- Disabled: The port will not transmit/receive packets, and will not perform learning
- Blocking: The port will only receive BPDU spanning tree protocol packets, but will not transmit any packets, and will not perform learning
- Learning: The port will receive any packet, including BPDU spanning tree protocol packets, and will perform learning, but will only transmit BPDU spanning tree protocol packets
- Forwarding: The port will transmit/receive all packets, and will perform learning

The RTL8363SC-VB also supports a per-port transmission/reception enable/disable function. Users can control the port state via register.



#### 9.16. Realtek Cable Test (RTCT)

The RTL8363SC-VB physical layer transceivers use DSP technology to implement the Realtek Cable Test (RTCT) feature. The RTCT function can be used to detect short, open, or impedance mismatch in each differential pair. The RTL8363SC-VB also provides LED support to indicate test status and results.

#### 9.17. LED Indicators

The RTL8363SC-VB supports parallel LEDs for each port. Each port has three LED indicator pins, PnLED0, PnLED1m and PnLED2. Each pin may have different indicator information (defined in Table 13). Refer to section 7.4 <u>LED Pins</u>, page 12 for pin details.

**LED Statuses** Description LED\_Off LED Pin Output Disable. Duplex/Collision Indicator. Blinking when collision occurs. Low for full duplex, and Dup/Col high for half duplex mode. Link, Activity Indicator. Low for link established. Link/Act Blinking when the Link/Act corresponding port is transmitting or receiving. Spd1000 1000Mbps Speed Indicator. Low for 1000Mbps. 100Mbps Speed Indicator. Low for 100Mbps. Spd100 Spd10 10Mbps Speed Indicator. Low for 10Mbps. 1000Mbps Speed/Activity Indicator. Low for 1000Mbps. Blinking when the Spd1000/Act corresponding port is transmitting or receiving. 100Mbps Speed/Activity Indicator. Low for 100Mbps. Blinking when the Spd100/Act corresponding port is transmitting or receiving. 10Mbps Speed/Activity Indicator. Low for 10Mbps. Blinking when the corresponding Spd10/Act port is transmitting or receiving. Spd100 (10)/Act 10/100Mbps Speed/Activity Indicator. Low for 10/100Mbps. Blinking when the corresponding port is transmitting or receiving. Activity Indicator. Act blinking when the corresponding port is transmitting or Act receiving.

**Table 13. LED Definitions** 

The LED pin also supports pin strapping configuration functions. The PnLED0, PnLED1, and PnLED2 pins are dual-function pins: input operation for configuration upon reset, and output operation for LED after reset. When the pin input is pulled high upon reset, the pin output is active low after reset. When the pin input is pulled down upon reset, the pin output is active high after reset. For details refer to Figure 7, page 30, and Figure 8, page 30. Typical values for pull-up/pull-down resistors are  $4.7K\Omega$ .

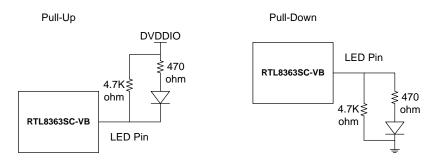
The PnLED1 can be combined with PnLED0 as a Bi-color LED.

LED PnLED1 should operate with the same polarity as other Bi-color LED pins. For example:

- P1LED1 should be pulled up upon reset if P1LED1 is combined with P1LED2 as a Bi-color LED, and P1LED2 input is pulled up upon reset. In this configuration, the output of these pins is active low after reset.
- P1LED1 should be pulled down upon reset if P1LED1 is combined with P1LED2 as a Bi-color LED, and P1LED2 input is pulled down upon reset. In this configuration, the output of these pins is active



high after reset.



LED Pins Output Active Low

LED Pins Output Active High

Figure 7. Pull-Up and Pull-Down of LED Pins for Single-Color LED

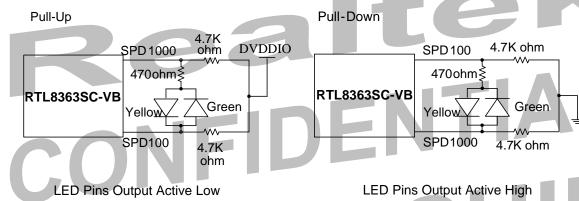


Figure 8. Pull-Up and Pull-Down of LED Pins for Bi-Color LED

#### 9.18. Green Ethernet

#### 9.18.1. Link-On and Cable Length Power Saving

The RTL8363SC-VB provides link-on and dynamic detection of cable length and dynamic adjustment of power required for the detected cable length. This feature provides high performance with minimum power consumption.

#### 9.18.2. Link-Down Power Saving

The RTL8363SC-VB implements link-down power saving on a per-port basis, greatly cutting power consumption when the network cable is disconnected. After it detects an incoming signal, it wakes up from link-down power saving and operates in normal mode.

#### 9.19. IEEE 802.3az Energy Efficient Ethernet (EEE) Function

The RTL8363SC-VB supports IEEE 802.3az Energy Efficient Ethernet ability for 1000Base-T and 100Base-TX in full duplex operation.



The Energy Efficient Ethernet (EEE) optional operational mode combines the IEEE 802.3 Media Access Control (MAC) sub-layer with 100Base-TX and 1000Base-T Physical Layers defined to support operation in Low Power Idle mode. When Low Power Idle mode is enabled, systems on both sides of the link can disable portions of the functionality and save power during periods of low link utilization.

- 1000Base-T PHY: Supports Energy Efficient Ethernet with the optional function of Low Power Idle
- 100Base-TX PHY: Supports Energy Efficient Ethernet with the optional function of Low Power Idle

The RTL8363SC-VB MAC uses Low Power Idle signaling to indicate to the PHY, and to the link partner, that a break in the data stream is expected, and components may use this information to enter power saving modes that require additional time to resume normal operation. Similarly, it informs the LPI Client that the link partner has sent such an indication.

#### 9.20. Regulator

The RTL8363SC-VB embeds a 3.3V-1.1V switch regulator to simplify the power solution. The 1.1V output power is used for the digital core and analog circuits. Do not use the regulator for other chips, even if the rating is enough.

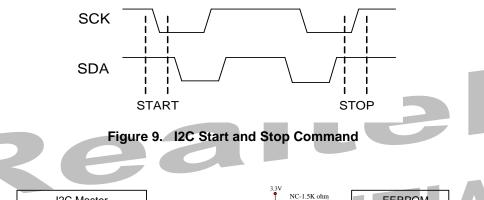
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#### 10. Interface Descriptions

#### 10.1. I2C Master for EEPROM Auto-load

The EEPROM interface of the RTL8363SC-VB uses the serial bus I<sup>2</sup>C to read the Serial EEPROM. When the RTL8363SC-VB is powered up, it drives SCK and SDA to read the configuration/code data from the EEPROM by strapping configuration.



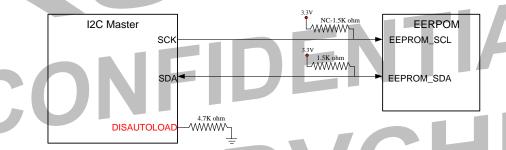


Figure 10. I2C Master for EEPROM Auto-load Interface Connection Example

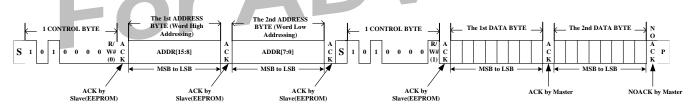


Figure 11. 16-Bit EEPROM Sequential Read



# 10.2. Realtek f C-Like Slave Interface for External CPU to Access RTL8363SC-VB

When EEPROM auto-load is complete, the RTL8363SC-VB registers can be accessed through SCK and SDA via an external CPU. The device address of the RTL8363SC-VB is 0x4. For the start and end of a write/read command, SCK needs one extra clock before/after the start/stop signals.

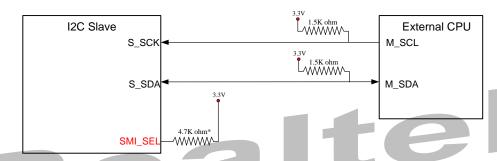


Figure 12. Realtek I2C-Like Slave for External CPU Access Interface Connection Example

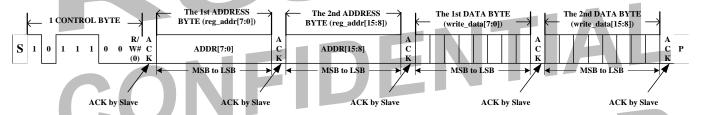


Figure 13. Realtek I2C-Like Slave Interface Write Command

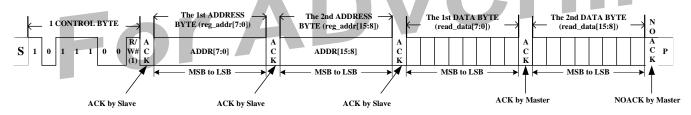


Figure 14. Realtek I2C-Like Slave Interface Read Command



# 10.3. Slave MII Management SMI Interface for External CPU to Access RTL8363SC-VB

The RTL8363SC-VB registers can be accessed via Slave MDC and MDIO via an external CPU (Decided by Strapping Configuration).

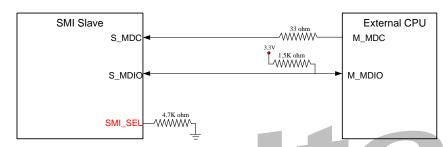


Figure 15. Slave MII Management SMI Interface Connection Example

Table 14. Slave MII Management SMI Access Format

	Management Frame Fields							
	PRE	ST	OP	DEVAD	REGAD	TA	DATA	IDLE
Read	11	01	10	AAAAA	RRRRR	Z0	DDDDDDDDDDDDDDD	Z
Write	11	01	01	AAAAA	RRRRR	10	DDDDDDDDDDDDDDD	Z

Note: The Slave needs no less than 32bit Preambles (PRE) for accessing slave by Slave SMI interface default. External CPU can configure the Slave to enable preamble suppression function, and then the Slave doesn't need preamble for accessing slave.



#### 11. Electrical Characteristics

#### 11.1. Absolute Maximum Ratings

WARNING: Absolute maximum ratings are limits beyond which permanent damage may be caused to the device, or device reliability will be affected. All voltages are specified reference to GND unless otherwise specified.

**Table 15. Absolute Maximum Ratings** 

Parameter	Min	Max	Units
Junction Temperature (Tj)	-	+125	°C
Storage Temperature	-45	+125	°C
DVDDIO, AVDDH, HV_SWR, Supply Referenced to GND, AGND, and GND_SWR	GND-0.3	+3.63	V
DVDDL, AVDDL, SVDDL, PLLVDDL, Supply Referenced to GND, and AGND	GND-0.3	+1.21	V
Digital Input Voltage	GND-0.3	VDDIO+0.3	V

#### 11.2. Recommended Operating Range

Table 16. Recommended Operating Range

			0		
Parameter		Min	Typical	Max	Units
Ambient Operating Temperature	0	-	70	°C	
DVDDIO Supply Voltage	3.3V	3.135	3.3	3.465	V
Range	2.5V	2.375	2.5	2.625	V
AVDDH and HV_SWR Supply	3.135	3.3	3.465	V	
DVDDL, AVDDL, SVDDL, and Range	PLLVDDL Supply Voltage	1.045	1.1	1.155	V



#### 11.3. Thermal Characteristics

#### 11.3.1. Assembly Description

**Table 17. Assembly Description** 

Package	Туре	QFN-56				
	Dimension (L×W)	$7 \times 7 \text{mm}^2$				
	Thickness	0.65mm				
PCB	PCB Dimension (L×W)	78.1×61.4mm <sup>2</sup>				
	PCB Thickness	1.6mm				
		4-Layer:				
		- 1st layer (1oz): 20% coverage of Cu				
	Number of Cu Layer-PCB	- 2nd layer (1oz): 80% coverage of Cu				
		- 3rd layer (1oz): 80% coverage of Cu				
		- 4th layer (1oz): 75% coverage of Cu				

#### 11.3.2. Material Properties

Table 18. Material Properties

Item		Material	Thermal Conductivity K (W/m-k)
	Die	Si	147
Doolraga	Silver Paste	1033BF	2.5
Package	Lead Frame	CDA7025	168
	Mold Compound	7372	0.9
DCD		Cu	400
	PCB		0.2

#### 11.3.3. Simulation Conditions

**Table 19. Simulation Conditions** 

1 4.0.1	10.0
Input Power	0.8W
Test Board (PCB)	4L (2S2P)
Control Condition	Air Flow = $0 \text{ m/s}$

### 11.3.4. Thermal Performance of QFN-56 on PCB Under Still Air Convection

Table 20. Thermal Performance of QFN-56 on PCB Under Still Air Convection

	$ heta_{ m JA}$	$ heta_{ m JB}$	$ heta_{ m JC}$	$\Psi_{ m JB}$
4L PCB	35.1	14.9	5.7	8.8

Note:

 $\theta_{IA}$ : Junction to ambient thermal resistance

 $\theta_{JB}$ : Junction to board thermal resistance

 $\theta_{JC}$ : Junction to case thermal resistance

 $\Psi_{JB}$ : Junction to bottom surface center of PCB thermal characterization



#### 11.4. DC Characteristics

**Table 21. DC Characteristics** 

Parameter	SYM	Min	Typical	Max	Units			
System Idle (All UTP Ports Link Down, and Extension Port Link/Active as HSGMII, without LEDs, disable								
internal SWR)								
Power Supply Current for VDDH	$I_{\text{DVDDIO}}, I_{\text{AVDDH}}$	-	14	-	mA			
Power Supply Current for VDDL	$I_{DVDDL}, I_{AVDDL}, I_{SVDDL}, I_{PLLVDDL}$	-	145	-	mA			
1000M Active (All UTP Ports 1000M Link/Active, an		ctive as	HSGMII,	without	LEDs,			
disable in	nternal SWR)							
Power Supply Current for VDDH	I <sub>DVDDIO</sub> , I <sub>AVDDH</sub>	-	129	-	mA			
Power Supply Current for VDDL	I <sub>DVDDL</sub> , I <sub>AVDDL</sub> , I <sub>SVDDL</sub> ,	-	320	-	mA			
	$I_{PLLVDDL}$							
VDD	0IO=3.3V							
TTL Input High Voltage	$V_{ih}$	2.0	-	-	V			
TTL Input Low Voltage	$V_{il}$	-	-	0.7	V			
Output High Voltage	$V_{oh}$	2.7	-	-	V			
Output Low Voltage	$V_{ol}$	-	/	0.6	V			
VDD	DIO=2.5V							
TTL Input High Voltage	$V_{ih}$	1.7	- //		V			
TTL Input Low Voltage	V <sub>il</sub>	-	-	0.6	V			
Output High Voltage	$V_{oh}$	2.25	-	-	V			
Output Low Voltage	$V_{ol}$	-		0.4	V			

Note: Over process, voltage and temperature, the maximum power dissipation is approximately 15% to 20% higher than the typical value.



#### 11.5. AC Characteristics

# 11.5.1. I<sup>2</sup>C Master for EEPROM Auto-load Interface Timing Characteristics

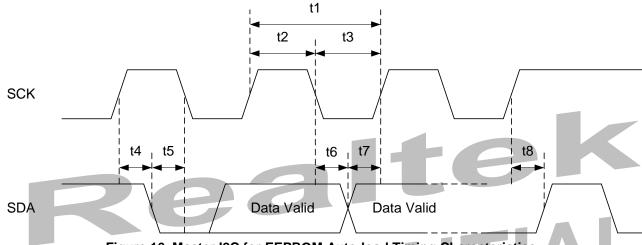


Figure 16. Master I2C for EEPROM Auto-load Timing Characteristics

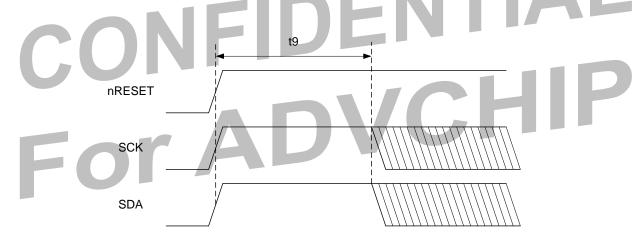


Figure 17. SCK/SDA Power on Timing

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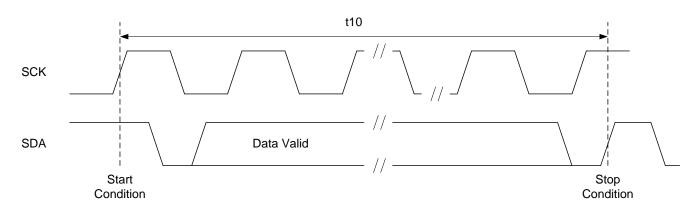


Figure 18. EEPROM Auto-Load Timing

Table 22. Master I2C for EEPROM Auto-load Timing Characteristics

Symbol	Description	Type	Min	Typical	Max	Units
t1	SCK Clock Period	О	9.7	10	-	μs
t2	SCK High Time	0	4.2	5	ı	μs
t3	SCK Low Time	0	4.2	5	-	μs
t4	START Condition Setup Time	О	4.8	5.04	1 -/	μs
t5	START Condition Hold Time	0	4.8	4.96	-	μs
t6	Data Hold Time	0	2.2	2.52		μs
t7	Data Setup Time	О	2.2	2.48		μs
t8	STOP Condition Setup Time	0	4.4	5.04	-	μs
t9	SCK/SDA Active from Reset Ready	О	75	78.4		ms
t10	8K-Bits EEPROM Auto-Load Time	О	250	278	-	ms
-	SCK Rise Time (10% to 90%)	0	-	320	-	ns
-	SCK Fall Time (90% to 10%)	О	- [	320	-	ns
-	Duty Cycle	0	48.86	50	51.14	%

#### 11.5.2. Realtek I<sup>2</sup>C-like Slave Mode Timing Characteristics

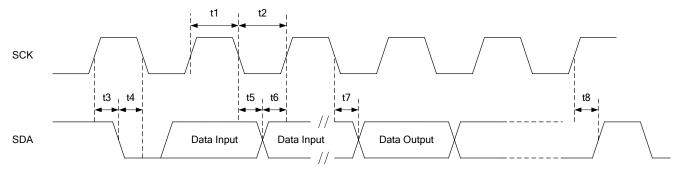


Figure 19. Realtek I2C-like Slave Mode Timing Characteristics

	Table 101 Realist 120 line Clare medic 11111119 Characteriolics								
Symbol	Description	Type	Min	Typical	Max	Units			
t1	SCK High Time	I	250	-	-	ns			
t2	SCK Low Time	I	250	-	-	ns			
t3	START Condition Setup Time	I	150	-	-	ns			
t4	START Condition Hold Time	I	150	-	-	ns			
t5	Data Hold Time	I	150	-	-	ns			
t6	Data Setup Time	I	150	-	-	ns			
t7	Clock to Data Output Delay	О	-	100	-	ns			
t8	STOP Condition Setup Time	I	150	-	-	ns			

Table 23. Realtek I2C-like Slave Mode Timing Characteristics

## 11.5.3. Slave MII Management SMI for External CPU Access Interface Timing Characteristics

The RTL8363SC-VB supports MDIO slave mode. The Master (CPU) can access the Slave (RTL8363SC-VB) registers via the MDIO interface. The MDIO is a bi-directional signal that can be sourced by the Master or the Slave. In a write command, the master sources the MDIO signal. In a read command, the slave sources the MDIO signal.

- The timing characteristics t1, t2, and t3 (Table 24) of the Master (the RTL8363SC-VB link partner CPU) are provided by the Master when the Master sources the MDIO signal (Write command)
- The timing characteristics t4 (Table 24) of the Slave (RTL8363SC-VB) are provided by the RTL8363SC-VB when the RTL8363SC-VB sources the MDIO signal (Read command)

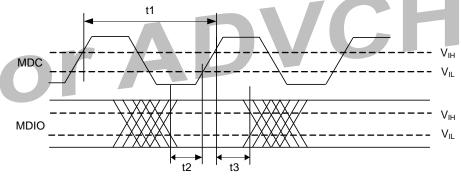


Figure 20. MDIO Sourced by the Master

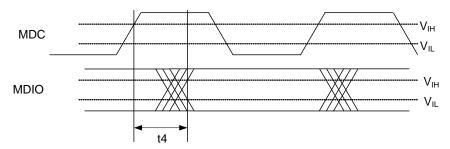


Figure 21. MDIO Sourced by the RTL8363SC-VB (Slave)



**Table 24. MDIO Timing Characteristics and Requirement** 

Parameter	SYM	<b>Description/Condition</b>	Type	Min	Typical	Max	Units
MDC Clock Period	t1	Clock Period	I	125	ı	ı	ns
MDIO to MDC Rising Setup Time (Write Data)	t2	Input Setup Time	I	25	1	-	ns
MDIO to MDC Rising Hold Time (Write Data)	t3	Input Hold Time	I	25	ı	1	ns
MDC to MDIO Delay Time (Read Data)	t4	Clock (Rising Edge) to Data Delay Time	О	0	. 1	80	ns

#### 11.5.4. HSGMII Characteristics

Table 25. HSGMII Differential Transmitter Characteristics

Table 25. Hoomin billerential Transmitter Orlanderistics								
Parameter	SYM	Min	Тур	Max	Units	Notes		
Unit Interval	UI	319.968	320	320.032	ps	320ps ±100ppm		
Eye Mask	T_X1	-	-	0.175	UI			
Eye Mask	T_X2	-	-	0.39	UI			
Eye Mask	T_Y1	400		-	mV	-		
Eye Mask	T_Y2	-	-	800	mV			
Output Differential Voltage	V <sub>TX-DIFFp-p</sub>	500	700	1000	mV	-		
Output Jitter TJ	T <sub>TX-JITTER</sub>	-	- 7	0.3	UI	$T_{\text{TX-JITTER-MAX}} = 1 - T_{\text{TX-EYE-MIN}} = 0.30UI$		
DJ		-	-	0.165	UI			
Minimum TX Eye Width	T <sub>TX-EYE</sub>	0.65		-	UI			
Output Rise Time	T <sub>TX-RISE</sub>	0.125	-	-	UI	20% ~ 80%		
Output Fall Time	T <sub>TX-FALL</sub>	0.125	- /	/ -\Y	UI	20% ~ 80%		
Differential Resistance	R <sub>TX</sub>	80	100	120	ohm	-		
AC Coupling Capacitor	$C_{TX}$	80	100	120	nF	-		
Transmit Length in PCB	$L_{TX}$	-	-	10	inch	-		



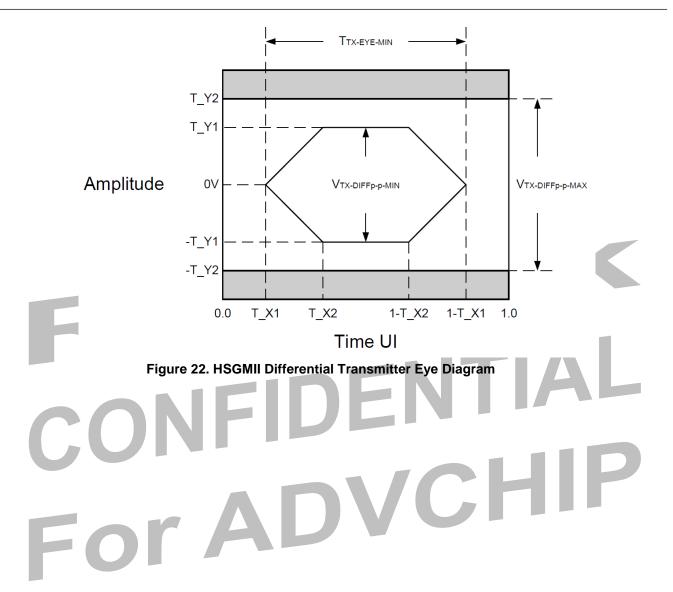




Table 26	HCCMII	Differential	Doggiver	Characteristics
Lable 76	HSGIVIII	Differential	Receiver	Characteristics

Parameter	SYM	Min	Тур	Max	Units	Notes
Unit Interval	UI	319.968	320	320.032	ps	320ps ±100ppm
Eye Mask	R_X1	-	-	0.275	UI	-
Eye Mask	R_Y1	100		-	mV	
Eye Mask	R_Y2	-	-	800	mV	-
Input Differential Voltage	V <sub>RX-DIFFp-p</sub>	200	-	1200	mV	-
Minimum RX Eye Width	$T_{RX-EYE}$	0.4	-	-	UI	-
Input Jitter Tolerance	$T_{RX ext{-JITTER}}$	-	-	0.6	UI	$T_{RX\text{-JITTER-MAX}} = 1 - T_{RX\text{-EYE-MIN}} = 0.6UI$
Differential Resistance	$R_{RX}$	80	100	120	ohm	-

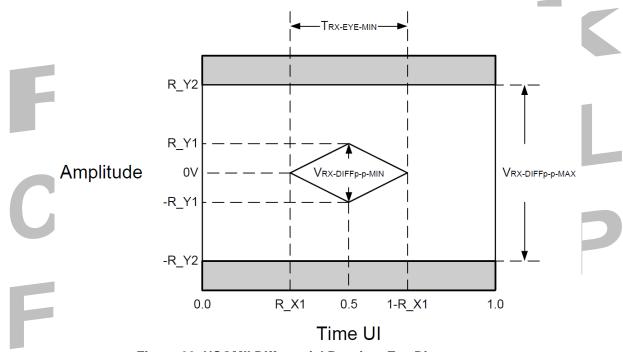


Figure 23. HSGMII Differential Receiver Eye Diagram



#### 11.5.5. SGMII/1000Base-X Characteristics

Table 2	7. SGMII/10	00Base-	X Diffe	erential	Transmit	ter	Characteristics	;

Parameter	SYM	Min	Тур	Max	Units	Notes
Unit Interval	UI	799.92	800	800.08	ps	800ps ±100ppm
Eye Mask	T_X1	-	ı	0.15	UI	-
Eye Mask	T_X2	-	1	0.4	UI	-
Eye Mask	T_Y1	150	1	-	mV	-
Eye Mask	T_Y2	-	1	400	mV	-
Output Differential Voltage	$V_{\text{TX-DIFFp-p}}$	300	700	800	mV	-
Minimum TX Eye Width	T <sub>TX-EYE</sub>	0.7	1	-	UI	-
Output Jitter	T <sub>TX-JITTER</sub>	-	-	0.3	UI	$T_{\text{TX-JITTER-MAX}} = 1 - T_{\text{TX-EYE-MIN}} = 0.30UI$
Data dependent jitter		-	70	-	ps	
Output Rise Time	$T_{TX ext{-RISE}}$	100	-	200	ps	20% ~ 80%
Output Fall Time	$T_{TX ext{-}FALL}$	100	-	200	ps	20% ~ 80%
Output impedance	$R_{TX}$	40	ı	140	ohm	single-end
AC Coupling Capacitor	$C_{TX}$	80	100	120	nF	
Transmit Length in PCB	$L_{TX}$			10	inch	

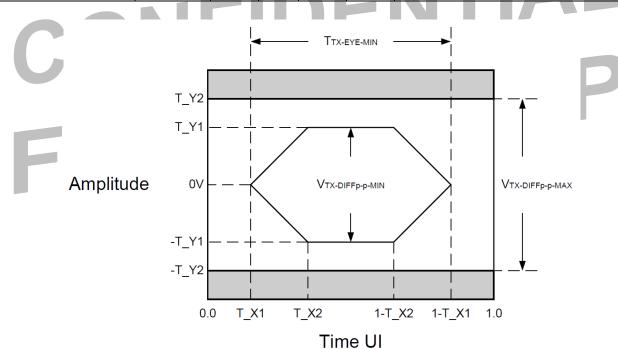


Figure 24. SGMII/1000Base-X Differential Transmitter Eye Diagram



Table 28	SGMII/1000Base-X	Differential	Receiver	Characteristics
i abie zo.	OGIVIII/ IUUUDASE-A	Differential	Receiver	CHAIACIENSUCS

Parameter	SYM	Min	Тур	Max	Units	Notes
Unit Interval	UI	799.92	800	800.08	ps	800ps ±100ppm
Eye Mask	R_X1	-	-	0.15	UI	-
Eye Mask	R_Y1	100	-	-	mV	-
Eye Mask	R_Y2	-	-	600	mV	-
Input Differential Voltage	V <sub>RX-DIFFp-p</sub>	200	-	1200	mV	-
Minimum RX Eye Width	$T_{RX-EYE}$	0.4	-	-	UI	-
Input Jitter Tolerance	T <sub>RX-JITTER</sub>	-	-	0.6	UI	$T_{RX-JITTER-MAX} = 1 - T_{RX-EYE-MIN} = 0.6UI$
Differential Resistance	$R_{RX}$	80	100	120	ohm	-

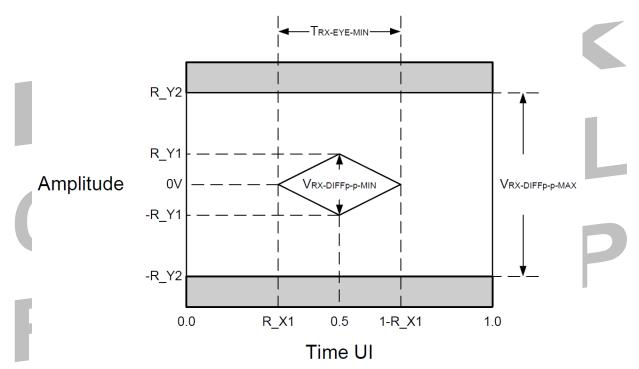


Figure 25. SGMII/1000Base-X Differential Receiver Eye Diagram



#### 11.6. Power and Reset Characteristics

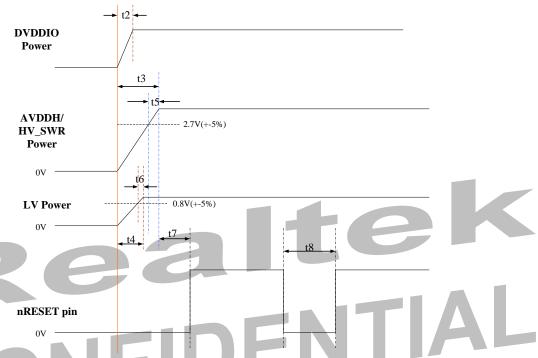


Figure 26. Power and Reset Characteristics

Table 29. Power and Reset Characteristics

Parameter	SYM	<b>Description/Condition</b>	Type	Min	Typical	Max	Units
DVDDIO Rising Time	t2	DVDDIO power rise settling time	I	0.5	1	-	ms
HV Power Rising Time	t3	AVDDH, HV_SWR(If embedded SWR be used) power rise settling time	I	0.5	1	-	ms
LV Power Rising Time	t4	DVDDL and AVDDL power rise settling time	I	0.5	-	-	ms
HV Power Ready Time after more than HV POR threshold	t5	The duration from HV power more than HV POR threshold to HV power ready	Ι	ı	-	10	ms
LV Power Ready Time after more than LV POR threshold	t6	The duration from LV power more than LV POR threshold to LV power ready	I	-	-	10	ms
Reset Delay Time	t7	The duration from 'all power steady' to the reset signal released to high	I	10	-	-	ms
Reset Low Time	t8	The duration of reset signal remaining low time before issuing a reset to RTL8363SC-VB	Ι	10	-	-	ms

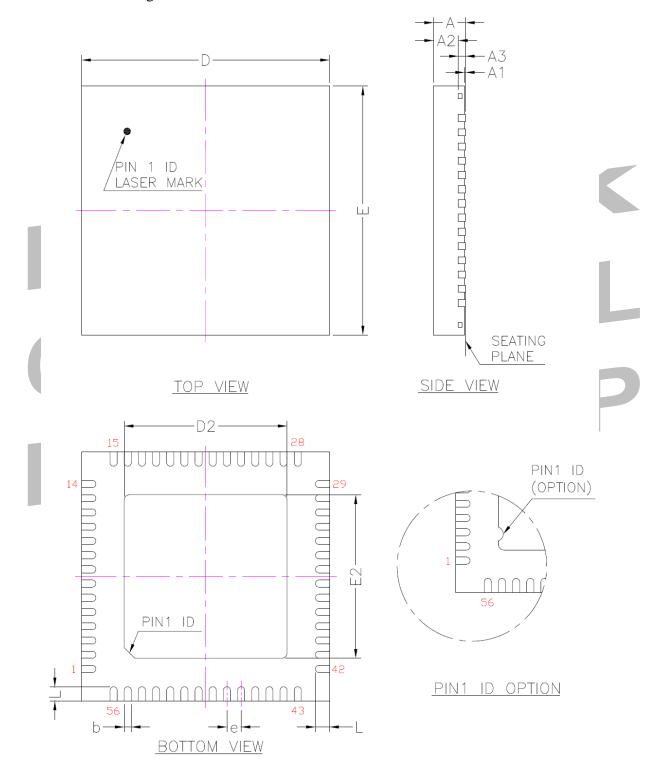
#### Note:

- 1) If the powers supply voltage of the RTL8363SC-VB lower than normal operation condition happened, the Power On Reset (POR) or Pin Reset be needed for normal operation of the RTL8363SC-VB.
- 2) AVDDH power must be ready no later than HV\_SWR power.



#### 12. Mechanical Dimensions

Quad Flat No-Lead Package 56 Leads 7x7mm<sup>2</sup> Outline.





Cymbol	]	Dimension in mn	า	Dimension in inch			
Symbol	Min	Nom	Max	Min	Nom	Max	
Α	0.80	0.85	0.90	0.031	0.033	0.035	
A <sub>1</sub>	0.00	0.02	0.05	0.000	0.001	0.002	
$A_2$		0.65	0.70		0.026	0.028	
$A_3$		0.2 REF			0.008 REF		
b	0.15	0.20	0.25	0.006	0.008	0.010	
D/E		7.00 BSC			0.276 BSC		
D <sub>2</sub> /E <sub>2</sub>	4.35	4.60	4.85	0.171	0.181	0.191	
е		0.40 BSC			0.016 BSC		
L	0.30	0.40	0.50	0.012	0.016	0.020	

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#### 13. Ordering Information

#### **Table 30. Ordering Information**

Part Number	Package	Status
RTL8363SC-VB-CG	QFN 56-Pin 'Green' Package	-

Note: See page 8 for package identification.



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